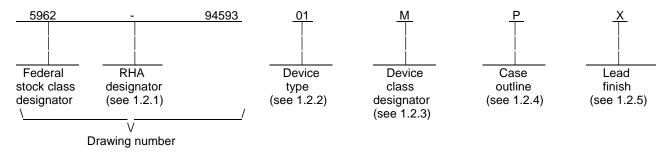
								F	REVISI	ONS										
LTR						DESCR	RIPTION	١					DATE (YR-MO-DA)			APPROVED				
Α	Chan	iges in	accord	lance v	vith N.C	D.R. 596	62-R17	9-96.					96-07-11				M. A. FRYE			
В	Draw	ring upo	dated to	o reflec	ct curre	nt requi	rement	s ro	)					00-1	0-12-20 R. N		R. MO	NNIN		
С	Add o	Add case outline "H" and radiation hardness requirements					ients	gt				02-0	7-31		R. MONNIN					
· ·																				
 REV																				
SHEET																				
SHEET REV																				
SHEET REV SHEET				REV	/		C	C	C	C	С	C	C	С	С	C				
SHEET REV SHEET REV STATUS DF SHEETS				SHE	EET		C 1	C 2	C 3	C 4	C 5	C 6	C 7	C 8	C 9	C 10				
MICR	NDAR	CUIT		SHE PRE RIC	EET PAREI	FICER	1				5	6	7 SE SI COL	8 JPPL UMBI	9 Y CE JS, O	10	43216	LUMBU	US	
SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STA MICRO DR THIS DRAWI	NDAR OCIRO AWING ING IS A' JSE BY A ARTMEN NCIES C	CUIT  G  VAILAE ALL TS  DF THE		CHE RA APP	PROVE	BY PITHAD ED BY FRYE	1 DIA	2		MIC FEE	DI CROC	EFEN CIRCU	SE SI COLI	JPPL UMBI DE://ww	y CE JS, O vw.ds	NTER	43216 a.mil Hz, C	CURR		

## 1. SCOPE

- 1.1 <u>Scope</u>. This drawing documents two product assurance class levels consisting of high reliability (device classes Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the PIN.
  - 1.2 PIN. The PIN is as shown in the following example:



- 1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
  - 1.2.2 <u>Device type(s)</u>. The device type(s) identify the circuit function as follows:

Device type	Generic number	<u>Circuit function</u>
01	AD8001	800 MHz, current feedback amplifier

1.2.3 <u>Device class designator</u>. The device class designator is a single letter identifying the product assurance level as follows:

<u>Device class</u> <u>Device requirements documentation</u>

M Vendor self-certification to the requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535,

appendix A

Q or V Certification and qualification to MIL-PRF-38535

1.2.4 <u>Case outline(s)</u>. The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
Р	GDIP1-T8 or CDIP2-T8	8	Dual-in-line
Н	GDFP1-F10	10	Flat pack

1.2.5 <u>Lead finish</u>. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

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## 1.3 Absolute maximum ratings. 1/

Supply voltage (V <sub>S</sub> )	12.6 V
Input voltage (common mode)	±Vs
Differential input voltage	_
Power dissipation (PD)	0.9 W 2/
Storage temperature range	<del>_</del>
Lead temperature range (soldering, 60 seconds)	+300°C
Thermal resistance, junction-to-case (θ <sub>JC</sub> )	See MIL-STD-1835
Thermal resistance, junction-to-ambient (θ <sub>JA</sub> )	
Case P	110°C/W
Case H	120°C/W

## 1.4 Recommended operating conditions.

Supply voltage (V <sub>S</sub> )	±5 V
Ambient operating temperature range (T <sub>A</sub> )	55°C to +125°C

## 1.5 Radiation features.

Maximum total dose available (dose rate = 50 - 300 rads(Si)/s) .......100 Krads(si) 3/

## 2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

## **SPECIFICATION**

## DEPARTMENT OF DEFENSE

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

#### **STANDARDS**

# DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

#### **HANDBOOKS**

- Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- 2/ Maximum internal power dissipation is specified so that the junction temperature dose not exceed +175°C. Derate at 9mW/°C for  $T_A > +32$ °C.
- 3/ These parts may be dose rate sensitive in a space environment and may demonstrate enhanced low dose rate effects. Radiation end point limits for the noted parameters are guaranteed only for the conditions specified in MIL-STD-883, method 1019, condition A.

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#### DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

#### 3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.
  - 3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein.
  - 3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.
- 3.2.3 <u>Radiation exposure circuit</u>. The radiation exposure circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing and acquiring activity upon request.
- 3.3 <u>Electrical performance characteristics and post irradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and post irradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.
- 3.5 <u>Marking</u>. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.
- 3.5.1 <u>Certification/compliance mark</u>. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.
- 3.6 <u>Certificate of compliance</u>. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change for device class M.</u> For device class M, notification to DSCC-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-PRF-38535.
- 3.9 <u>Verification and review for device class M.</u> For device class M, DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

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No	Symbol	Conditions $\underline{1}/\underline{2}/\underline{3}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified	Group A subgroups	Device type	Lir	nits	Unit
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $					Min	Max	
Positive input bias current $A = A = A = A = A = A = A = A = A = A $			1	01		5.5	m\/
Positive input bias current	vos	MDDID	-				- '''`
Positive input bias current $+I_{ B}$ $= 1$ $= $		WI, D, P, L, R	-				4
M, D, P, L, R	11			01	-6		пΔ
Negative input bias current   -I <sub>IB</sub>	+IIB	MDDID					μ.
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		M, D, P, L, R	-				
$ \begin{array}{ c c c c c c c c } \hline M, D, P, L, R & 1 & -25 & +25 & \\ \hline & & & & & & & & & & \\ \hline & & & & &$				01			пΔ
Common mode rejection ratio   A   Vout   ±2.5 V   A   O1   250   KΩ	-IB	MDDID					μ.
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		WI, D, P, L, R	-				4
$ \frac{4/}{4/}                                $	D	V 12.5.V		01		+33	kO
Input characteristics section Common mode rejection ratio $\underline{4}/$ CMRR $\underline{4}/$ VCM = $\pm 2.5 \text{ V}$ $\underline{1}$ $01$ $50$ $47$ $01$ $01$ $01$ $01$ $01$ $01$ $01$ $01$	KOLT	VOUT = ±2.5 V					- 1132
Common mode rejection ratio         CMRR $\underline{4}$ V <sub>CM</sub> = ±2.5 V         1         01         50         dB           Output characteristics section         00 Uput voltage swing $\underline{4}$ / Vout         R <sub>L</sub> = 150 Ω         1         01         -2.7         +2.7         V           Output current $\underline{4}$ / lout         R <sub>L</sub> = 37.5 Ω, T <sub>A</sub> = +25°C         1         01         50         mA           Short circuit current $\underline{4}$ / los         T <sub>A</sub> = +25°C         1         01         85         mA           Power supply section         Power supply operating $\underline{4}$ / range         V <sub>PS</sub> 1,2,3         01         ±3         ±6         V           Quiescent current         IQ         1         01         5.5         mA           Power supply rejection ratio         PSRR         +V <sub>S</sub> = +4 V to +6 V, -V <sub>S</sub> = -5 V         1,2,3         01         60         dB			5,0		175		
Power supply operating $\frac{4}{4}$ $V_{OUT}$ $V$	CMRR	V <sub>CM</sub> = ±2.5 V	1	01	50		dB
Output characteristics section         Output voltage swing $4$ / Vout $R_L = 150 \Omega$ 1         01         -2.7         +2.7         V           Output current $4$ / Iout $R_L = 37.5 \Omega$ , $T_A = +25^{\circ}C$ 1         01         50         mA           Short circuit current $4$ / Ios $T_A = +25^{\circ}C$ 1         01         85         mA           Power supply section         Power supply operating $4$ / range $V_P$ S         1,2,3         01         ±3         ±6         V           Quiescent current         IQ         1         01         5.5         mA           Power supply rejection ratio         PSRR         +Vs = +4 V to +6 V, -Vs = -5 V -Vs = -5 V         1,2,3         01         60         dB           4/         -Vs = -5 V -Vs = -4 V to -6 V,         1         50         50         50		OW	2.2		47		-
Output voltage swing $\frac{4}{2}$ VOUT         R <sub>L</sub> = 150 Ω         1         01         -2.7         +2.7         V           Output current $\frac{4}{2}$ Iout         R <sub>L</sub> = 37.5 Ω, T <sub>A</sub> = +25°C         1         01         50         mA           Short circuit current $\frac{4}{2}$ Ios         T <sub>A</sub> = +25°C         1         01         85         mA           Power supply section         Power supply operating $\frac{4}{2}$ VPS         1,2,3         01         ±3         ±6         V           Quiescent current         IQ         1         01         5.5         mA           Power supply rejection ratio         PSRR         +V <sub>S</sub> = +4 V to +6 V, -V <sub>S</sub> = -5 V         1,2,3         01         60         dB           -V <sub>S</sub> = -5 V         -V <sub>S</sub> = -4 V to -6 V,         1         50         50         50	<u> </u> n		2,3		41		
Output current $4$ / Iout         R <sub>L</sub> = 37.5 Ω, T <sub>A</sub> = +25°C         1         01         50         mA           Short circuit current $4$ / Ios         T <sub>A</sub> = +25°C         1         01         85         mA           Power supply section         Power supply operating $4$ / range         V <sub>PS</sub> 1,2,3         01         ±3         ±6         V           Quiescent current         IQ         1         01         5.5         mA           M, D, P, L, R         1         5.5         6.0           Power supply rejection ratio         PSRR         +V <sub>S</sub> = +4 V to +6 V, -V <sub>S</sub> = -5 V         1,2,3         01         60         dB           -V <sub>S</sub> = -5 V         -V <sub>S</sub> = -4 V to -6 V,         1         50         50         50	1	R <sub>1</sub> = 150 O	1	01	-2.7	+2.7	V
Output current $4/$ IouT $R_L = 37.5 \ \Omega$ , $T_A = +25^{\circ}C$ 1         01         50         mA           Short circuit current $4/$ Ios $T_A = +25^{\circ}C$ 1         01         85         mA           Power supply section         Power supply operating $4/$ range         VPS         1,2,3         01 $\pm 3$ $\pm 6$ V           Quiescent current         IQ         1         01         5.5         mA           M, D, P, L, R         1         01         5.5         6.0           Power supply rejection ratio         PSRR $+V_S = +4 \ V \ to +6 \ V$ , $-V_S = -5 \ V$ 1,2,3         01         60         dB $4/$ $-V_S = -4 \ V \ to -6 \ V$ ,         1         50         50         50	V001	17[ - 150 22	23				-
Short circuit current $4/$ $I_{OS}$ $T_{A} = +25^{\circ}C$ 1 01 85 mA  Power supply section  Power supply operating $4/$ $V_{PS}$ 1,2,3 01 $\pm 3$ $\pm 6$ $V$ range Quiescent current $I_{Q}$ 1 01 5.5 mA	Іонт	R <sub>1</sub> = 37.5 Ω. T <sub>Δ</sub> = +25°C		01		12.0	mA
Power supply section  Power supply operating 4/			1	01	0.5		mΛ
Power supply operating $\frac{4}{}$ $V_{PS}$	los	$T_A = +25^{\circ}C$	1	01	65		IIIA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$							
Quiescent current $I_Q$ $M, D, P, L, R$ $1$ $5.5$ $MA$ Power supply rejection ratio $PSRR$ $V_S = +4 \ V \ to \ +6 \ V, V_S = -5 \ V$ $-V_S = -4 \ V \ to \ -6 \ V, 1$ $1$ $1$ $1$ $1$ $1$ $1$ $1$ $1$ $1$	V <sub>PS</sub>		1,2,3	01	±3	±6	V
Power supply rejection ratio $PSRR$	IQ		1	01		5.5	mA
Power supply rejection ratio $PSRR = +V_S = +4 \ V \ to +6 \ V,                                  $		M. D. P. L. R	1	1		5.5	1
ratio $\frac{4}{} = \frac{1.0 \times 10^{-14} \times 10^{-16} \times 10^{-16}$		, =, . , =,	· ·	-			1
$ \frac{4}{} - V_{S} = -5 V \\ -V_{S} = -4 V \text{ to } -6 V, \qquad 1 \qquad 50 $	PSRR	+V <sub>S</sub> = +4 V to +6 V,	1,2,3	01	60		dB
<u>4/</u> -V <sub>S</sub> = -4 V to -6 V, 1 50		-V <sub>S</sub> = -5 V					
			1	1	50		1
			0.0		47		4
		Vos  +IIB  -IIB  ROLT  CMRR  IOUT  IOUT  IOS  VPS  IQ	Symbol $^{-55}^{\circ}$ C $\leq$ T <sub>A</sub> $\leq$ +125°C unless otherwise specified         VOS       M, D, P, L, R         +IIB       M, D, P, L, R         ROLT       VOUT = ±2.5 V         CMRR       V <sub>CM</sub> = ±2.5 V         NOUT       R <sub>L</sub> = 150 Ω         IOUT       R <sub>L</sub> = 37.5 Ω, T <sub>A</sub> = +25°C         IOS       T <sub>A</sub> = +25°C         VPS       IQ         M, D, P, L, R         PSRR       +V <sub>S</sub> = +4 V to +6 V, -V <sub>S</sub> = -5 V -V <sub>S</sub> = -4 V to -6 V,	$ \begin{array}{ c c c c c } \hline Symbol & -55^{\circ}C \leq T_{A} \leq +125^{\circ}C & Group \ A & subgroups \\ \hline \\ \hline VOS & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c c } \hline Symbol & -55^{\circ}C \leq T_{A} \leq +125^{\circ}C \\ & unless otherwise specified & Subgroups & Device type & Limits & Min & Max & Max & Min $

See footnotes at end of table.

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	TABLE	I. Electrical performance chara	ucteristics – Co	ntinued.			
Test	1 Ovilibol i	Group A subgroups	Device type	Liı	mits	Unit	
					Min	Max	
Dynamic performance section	1			·		_	·
Small signal bandwidth  4/ 5/	SSBW	-3 dB, G = +2, R <sub>F</sub> = 750 $\Omega$ , peaking < 0.1 dB, $T_A = +25$ °C	4	01	350		MHz
		-3 dB, G = +1, R <sub>F</sub> = 1 kΩ, peaking < 1 dB, $T_A$ = +25°C			650		
Bandwidth for 0.1 dB flatness 4/ 5/	BW	$G = +2$ , $R_F = 750 Ω$ , $T_A = +25$ °C	4	01	85		MHz
Slew rate <u>4</u> / <u>5</u> /	SR	$G = +2$ , $V_{OUT} = 2$ V step, $T_A = +25$ °C	4	01	800		V/μs
		$G = -1$ , $V_{OUT} = 2 \text{ V step}$ , $T_A = +25^{\circ}\text{C}$			960		
Noise and harmonic performa	nce section	1					
Differential gain error 4/ 5/	DGE	$G = +2$ , $R_L = 150 Ω$ , $T_A = +25$ °C	4	01		0.025	%
Differential phase error <u>4</u> / <u>5</u> /	DPE	$G = +2$ , $R_L = 150 Ω$ , $T_A = +25$ ° $C$	4	01		0.04	Degree

- 1/ Devices supplied to this drawing will meet all levels M, D, P, L, R of irradiation. However, this device is only tested at the "R" level. Pre and Post irradiation values are identical unless otherwise specified in table I. When performing post irradiation electrical measurements for any RHA level, T<sub>A</sub> = +25°C.
- 2/ These parts may be dose rate sensitive in a space environment and may demonstrate enhanced low dose rate effects. Radiation end point limits for the noted parameters are guaranteed only for the conditions specified in MIL-STD-883, method 1019, condition A.
- $\underline{3}$ / Unless otherwise specified,  $V_S = \pm 5 \text{ V}$  and  $R_L = 100 \Omega$ .
- 4/ Not tested post irradiation.
- 5/ If not tested, shall be guaranteed to the limits specified in table I herein.

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Device type	01		
Case outline	Р	Н	
Terminal number	Terminal symbol	Terminal symbol	
1	NC	NC	
2	-INPUT	NC	
3	+INPUT	-INPUT	
4	-V <sub>S</sub>	+INPUT	
5	NC	-V <sub>S</sub>	
6	OUTPUT	NC	
7	+V <sub>S</sub>	OUTPUT	
8	NC	+V <sub>S</sub>	
9		NC	
10		NC	

NC = no connection

FIGURE 1. <u>Terminal connections</u>.

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- 3.10 <u>Microcircuit group assignment for device class M</u>. Device class M devices covered by this drawing shall be in microcircuit group number 49 (see MIL-PRF-38535, appendix A).
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.
  - 4.2.1 Additional criteria for device class M.
    - a. Burn-in test, method 1015 of MIL-STD-883.
      - (1) Test condition B. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
      - (2)  $T_A = +125^{\circ}C$ , minimum.
    - b. Interim and final electrical test parameters shall be as specified in table IIA herein.
  - 4.2.2 Additional criteria for device classes Q and V.
    - a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
    - b. Interim and final electrical test parameters shall be as specified in table IIA herein.
    - c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.
- 4.3 <u>Qualification inspection for device classes Q and V.</u> Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).
- 4.4 <u>Conformance inspection</u>. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified herein. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).
  - 4.4.1 Group A inspection.
    - a. Tests shall be as specified in table IIA herein.
    - b. Subgroups 7, 8, 9, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.

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#### TABLE IIA. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device class M	Device class Q	Device class V
Interim electrical parameters (see 4.2)			
Final electrical parameters (see 4.2)	1,2,3,4,5,6 <u>1</u> /	1,2,3,4,5,6 <u>1</u> /	1,2,3,4,5,6 <u>1</u> / <u>2</u> /
Group A test requirements (see 4.4)	1,2,3,4,5,6	1,2,3,4,5,6	1,2,3,4,5,6
Group C end-point electrical parameters (see 4.4)	1	1	1 <u>2</u> /
Group D end-point electrical parameters (see 4.4)	1	1	1
Group E end-point electrical parameters (see 4.4)			1

- 1/ PDA applies to subgroup 1. Deltas excluded from PDA.
- 2/ See table IIB for delta parameters. See table I for conditions.

Table IIB. 240 burn-in and group C end-point electrical parameters.

Parameter	Device type	Burn-in Limit	Life test limit	Delta Limit
lq	01	5.5 mA	6.0 mA	0.55 mA
Vos	01	±5.5 mV	±7.5 mV	±2.0 mV

- 4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table IIA herein.
- 4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:
  - a. Test condition B. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
  - b.  $T_A = +125^{\circ}C$ , minimum.
  - c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
- 4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
  - 4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.

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- 4.4.4 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein). RHA levels for device classes M, Q, and V shall be as specified in MIL-PRF-38535. End-point electrical parameters shall be as specified in table IIA herein.
- 4.4.4 <u>Total dose irradiation testing</u>. Total dose irradiation testing shall be performed in accordance with MIL-STD-883 method 1019 condition A and as specified herein.
  - 5. PACKAGING
- 5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.
  - 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor prepared specification or drawing.
  - 6.1.2 Substitutability. Device class Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.
- 6.3 <u>Record of users</u>. Military and industrial users should inform Defense Supply Center Columbus when a system application requires configuration control and which SMD's are applicable to that system. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.
- 6.4 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA , Columbus, Ohio 43216-5000, or telephone (614) 692-0547.
- 6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.
  - 6.6 Sources of supply.
- 6.6.1 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DSCC-VA and have agreed to this drawing.
- 6.6.2 <u>Approved sources of supply for device class M.</u> Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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#### STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 02-07-31

Approved sources of supply for SMD 5962-94593 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-9459301MPA	24355 (2)	AD8001SQ
5962-9459301VPA	24355 (5)	AD8001SQ/QMLV
5962-9459301VHA	24355 (5)	AD8001SL/QMLV
5962R9459301VPA	24355 (5)	AD8001SQ/QMLR
5962R9459301VHA	24355 (5)	AD8001SL/QMLR

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

 Vendor CAGE
 Vendor name

 number
 and address

24355 Analog Devices (2)

RT 1 Industrial Park PO Box 9106 Norwood, MA 02062

Point of contact: 804 Woburn Street

Wilmington, MA 01887-3462

24355 Analog Devices (5)

RT 1 Industrial Park PO Box 9106 Norwood, MA 02062

Point of contact: 1500 Space Park Drive

PO Box 58020

Santa Clara, CA 95052-8020

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.